

120V N-Ch Power MOSFET

Feature

High Speed Power Switching, Logic Level

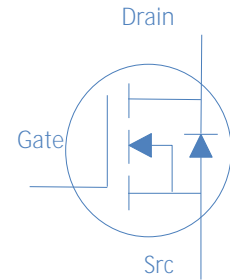
Enhanced Body diode dv/dt capability

Enhanced Avalanche Ruggedness

100% UIS Tested, 100% Rg Tested

Lead Free, T_f 262 520 2 reW nBT/F4 2.168 f1 0 0 1 612 65333 Tm0 g9f1 0 0 1 612 65333 Tm0 g0 G

V _{DS}		120	V
R _{DS(on),typ}	V _{GS} =10V	9.8	m
R _{DS(on),typ}	V _{GS} =4.5V	12.0	m
I _D (Silicon Limited)		68	A



Part Number	Package	Marking
HGI130N12SL	TO-251	GI130N12SL
HGD130N12SL	TO-252	GD130N12SL

Absolute Maximum Ratings at T_j

Parameter	Symbol	Conditions	Value	Unit
Continuous Drain Current (Silicon Limited)	I _D	T _C	68	A
		T _C	48	
Drain to Source Voltage	V _{DS}	-	120	V
Gate to Source Voltage	V _{GS}	-	20	V
Pulsed Drain Current	I _{DM}	-	260	A
Avalanche Energy, Single Pulse	E _{AS}	L=0.4mH, T _C	320	mJ
Power Dissipation	P _D	T _C	136	W
Operating and Storage Temperature	T _J , T _{stg}	-	-55 to175	

Absolute Maximum Ratings

Parameter	Symbol	Max	Unit
Thermal Resistance Junction-Ambient	R _{JA}	50	
Thermal Resistance Junction-Case	R _{JC}	1.1	

Electrical Characteristics at T_j
Static Characteristics

Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
Drain to Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250 A$	120	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250 A$	1.4	2.0	2.4	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{GS}=0V, V_{DS}=120V, T_j$	-	-	1	A
		$V_{GS}=0V, V_{DS}=120V, T_j$	-	-	100	
Gate to Source Leakage Current	I_{GSS}	$V_{GS} \leq 9V, V_{DS}=0V$	-	-	100	nA
Drain to Source on Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$	-	9.8	12.5	m
Drain to Source on Resistance	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=20A$	-	12	17	m
Transconductance	g_{fs}	$V_{DS}=5V, I_D=20A$	-	65	-	S
Gate Resistance	R_G	$V_{GS}=0V, V_{DS} \text{ Open}, f=1MHz$	-	2.2	-	

Dynamic Characteristics

Input Capacitance	C_{iss}	$V_{GS}=0V, V_{DS}=60V, f=1MHz$	-	2056	-	pF
Output Capacitance	C_{oss}		-	222	-	
Reverse Transfer Capacitance	C_{rss}		-	7.9	-	
Total Gate Charge	$Q_g(10V)$	$V_{DD}=60V, I_D=20A, V_{GS}=10V$	-	31	-	nC
Total Gate Charge	$Q_g(4.5V)$		-	15	-	
Gate to Source Charge	Q_{gs}		-	8	-	
Gate to Drain (Miller) Charge	Q_{gd}		-	4	-	
Turn on Delay Time	$t_{d(on)}$	$V_{DD}=60V, I_D=20A, V_{GS}=10V, R_G=10 \Omega$	-	11	-	ns
Rise time	t_r		-	9	-	
Turn off Delay Time	$t_{d(off)}$		-	18	-	
Fall Time	t_f		-	10	-	

Reverse Diode Characteristics

Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_F=20A$	-	0.9	1.2	V
Reverse Recovery Time	t_{rr}	$V_R=60V, I_F=20A, dI_F/dt=100A/\mu s$	-	50	-	ns
Reverse Recovery Charge	Q_{rr}		-	75	-	nC

Fig 1. Typical Output Characteristics

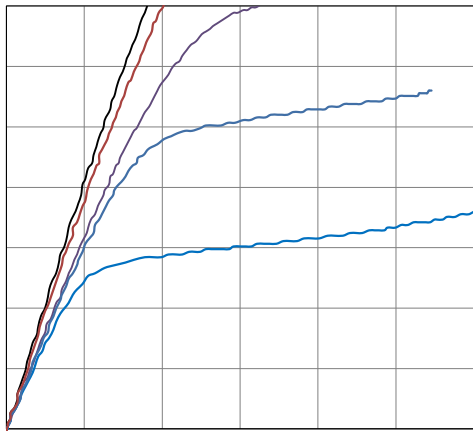


Figure 2. On-Resistance vs. Gate-Source Voltage

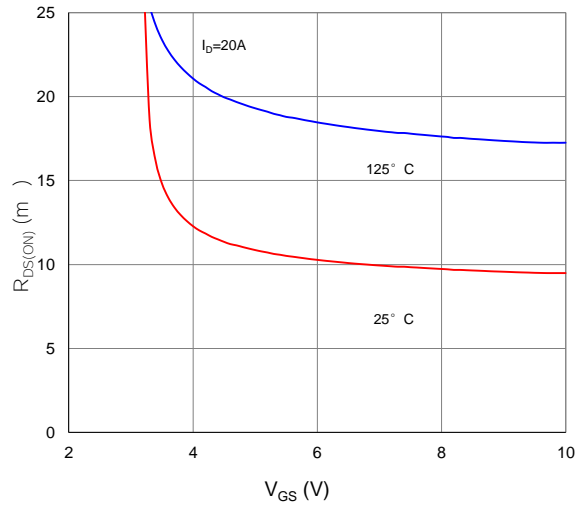


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

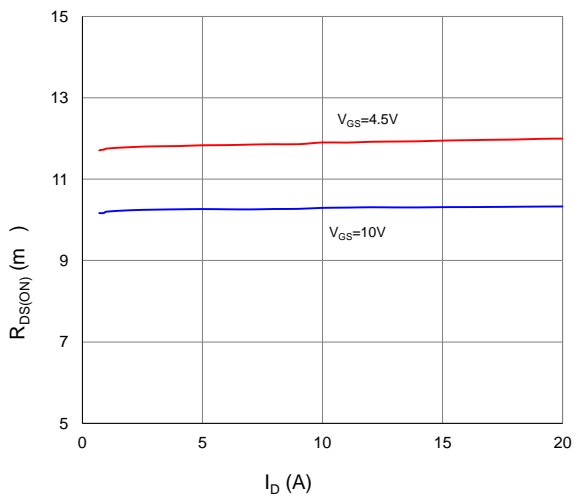


Figure 4. Normalized On-Resistance vs. Junction Temperature

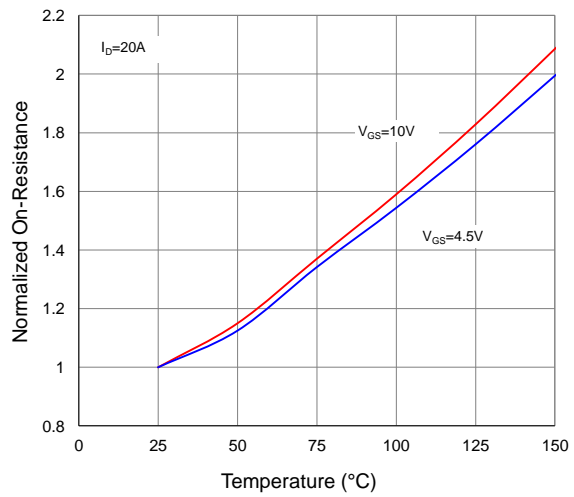


Figure 5. Typical Transfer Characteristics

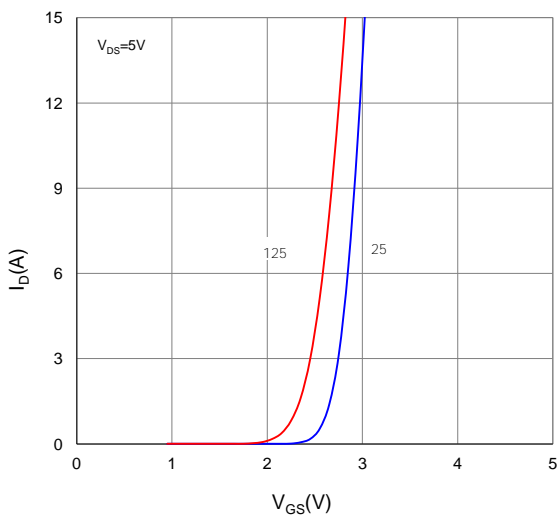


Figure 6. Typical Source-Drain Diode Forward Voltage

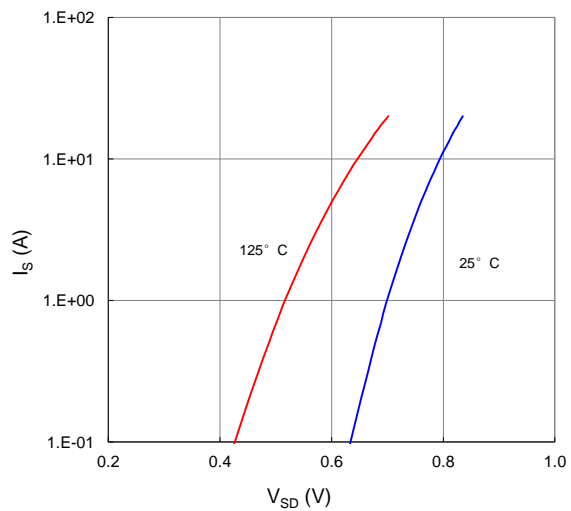


Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

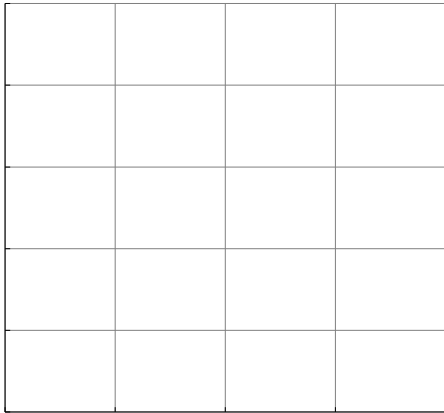


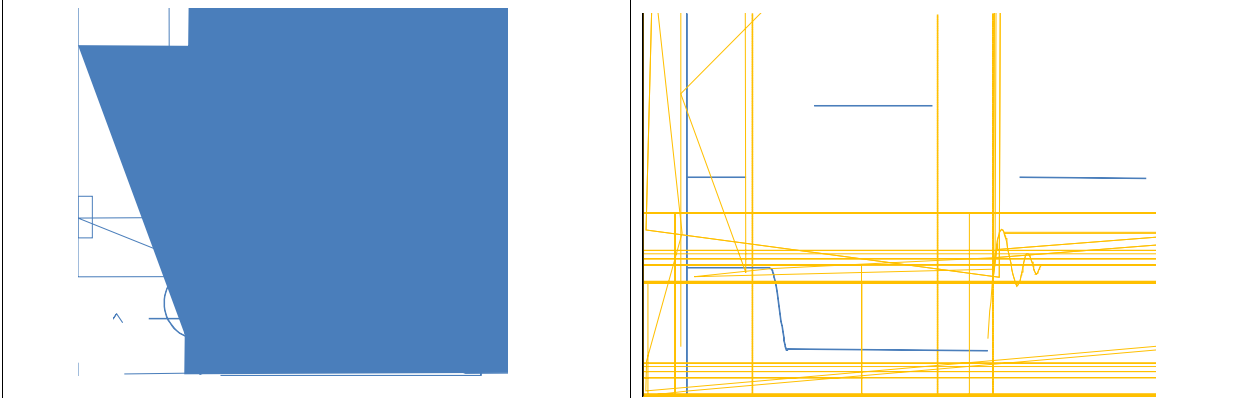
Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

Figure 9. Maximum Safe Operating Area

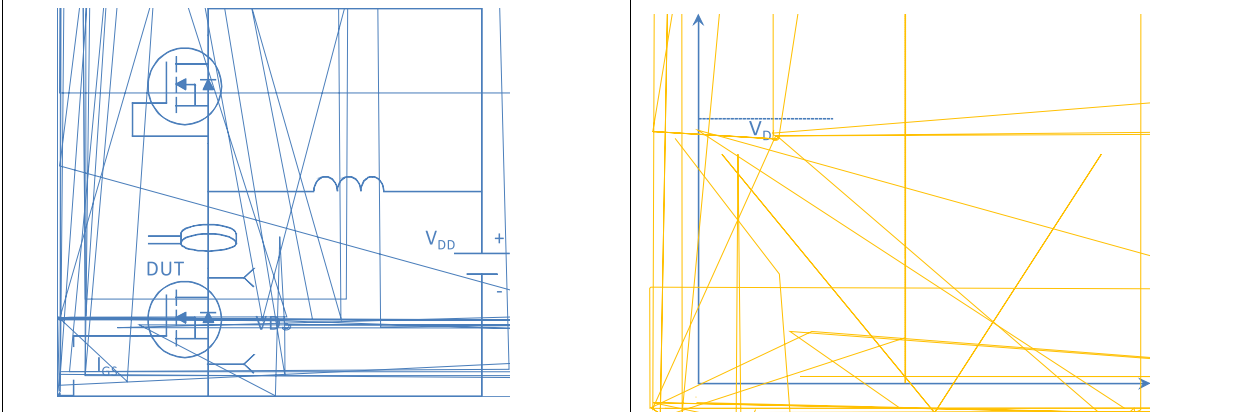
Figure 10. Maximun Drain Current vs. Case Temperature

Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Ambient

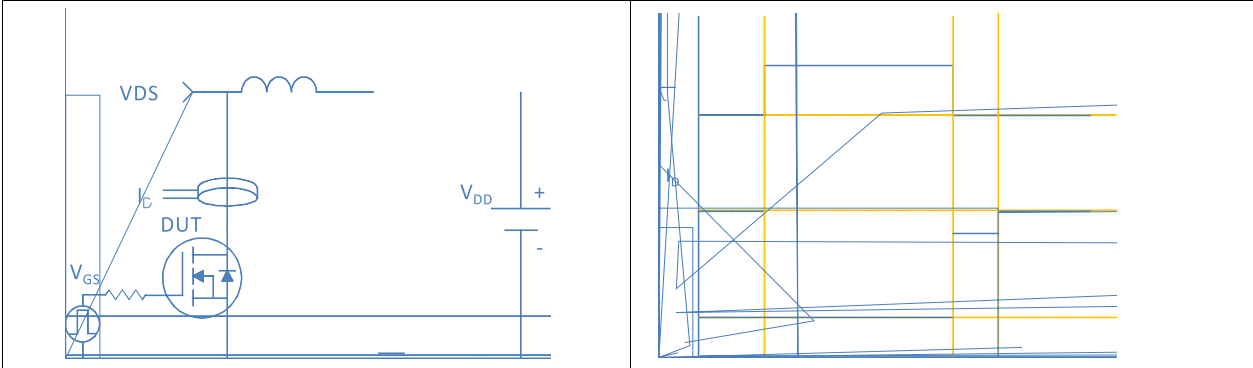
Inductive switching Test



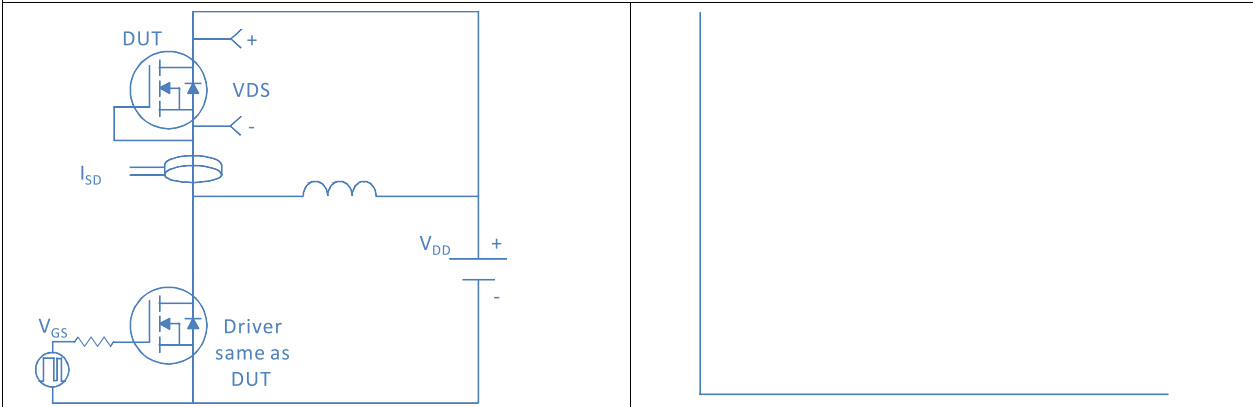
Gate Charge Test



Uclamped Inductive Switching (UIS) Test

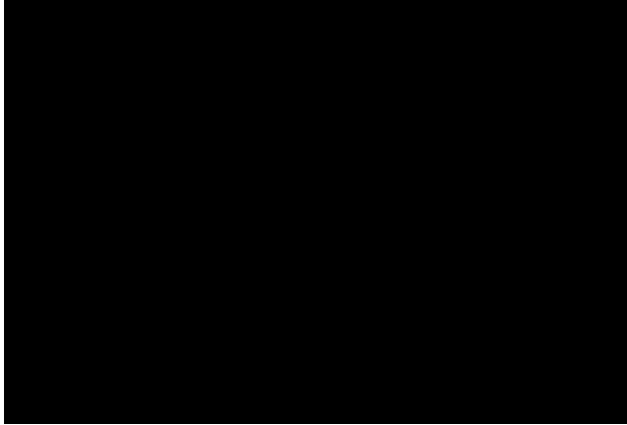


Diode Recovery Test

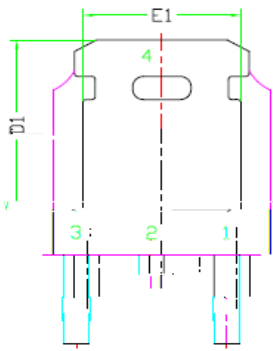


Package Outline

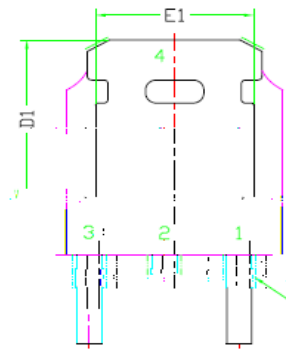
TO-252, 2 Leads



SYMBOL	DIMENSIONAL REQMTS		
	MIN	NOM	MAX
E	6.40	6.60	6.731
L	1.40	1.52	1.77
L1	2.743 REF		
L2	0.508 BSC		
L3	0.89	--	1.27
L4	0.64	--	1.01
L5	--	--	--
D	6.00	6.10	6.223



SINGLE ROW(NEW)

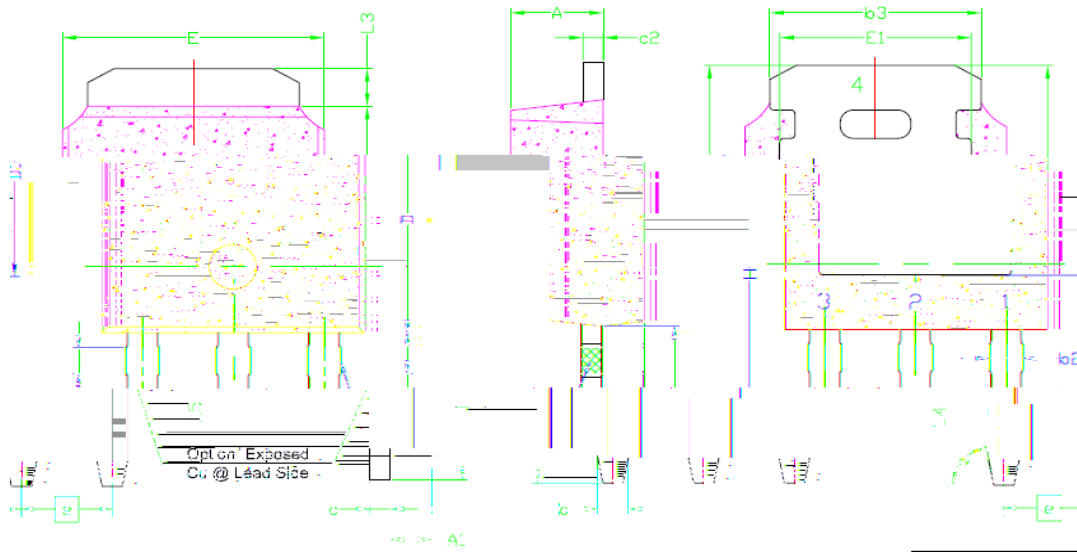


MATRIX L/F

COPPER EXPOSITION AREA

Package Outline

TO-251, 3 leads



SYMBOL	DIMENSIONAL REQMTS		
	MIN	NOM	MAX
E	6.40	6.60	6.731
L	3.98	4.13	4.28
L3	0.89	--	1.27
L4	0.698 REF		
L5	0.972	1.099	1.226
D	6.00	6.10	6.223
H	11.05	11.25	11.45
b	0.64	0.76	0.88
b2	0.77	0.84	1.14
b3	5.21	5.34	5.46
e	2.286 BSC		
A	2.20	2.30	2.38
A1	0.89	1.04	1.15
c	0.46	0.50	0.60
c2	0.46	0.50	0.60
D1	5.10	--	--
E1	4.40	--	--
a	79° REF		